

## Special Issue

# Precision Grinding of Brittle Materials: Techniques and Applications

### Message from the Guest Editor

Brittle materials are widely used in the optical, semiconductor, electronics, and medical industries. However, machining these materials presents significant challenges due to their tendency to fracture or develop defects, requiring precise control of processing parameters. In response to growing demands in the optoelectronic industry, this Special Issue aims to serve as a platform to explore the latest progress, challenges, and opportunities in the domain of “Precision Grinding of Brittle Materials: Techniques and Applications”.

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### Guest Editor

Prof. Dr. Dekui Mu  
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### Deadline for manuscript submissions

closed (20 June 2025)



## Applied Sciences

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As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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### Editor-in-Chief

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